

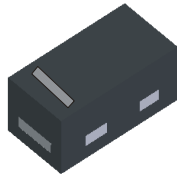
NEW PRODUCT

Features

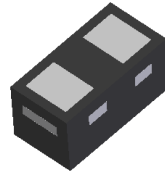
- Ultra-Small Leadless Surface Mount Package (0.6 x 0.3mm)
- Ultra-Low Profile Package (0.3mm)
- Very Low Leakage Current
- Low Capacitance
- Ideal for Compact Battery Powered Portable Electronics
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **"Green" Device (Note 2)**

Mechanical Data

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish – Matte Tin Finish over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.2mg (Approximate)



Top View



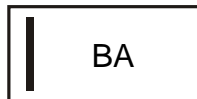
Bottom View

Ordering Information (Note 3)

Part Number	Case	Packaging
BAS116LP3-7	X3-DFN0603-2	10,000/Tape & Reel

- Notes:
1. No purposefully added lead.
 2. Diodes Inc.'s "Green" policy can be found on our website at <http://www.diodes.com>.
 3. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



BA = Product Type Marking Code
Bar Denotes Cathode Side

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	85	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	60	V
Forward Continuous Current (Note 4)	I _{FM}	215	mA
Repetitive Peak Forward Current	I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	@ t = 1.0μs	4.0
		@ t = 1.0ms	1.0
		@ t = 1.0s	0.5

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 4)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	85	—	—	V	I _R = 100μA
Forward Voltage	V _F	—	0.75	0.95	V	I _F = 1.0mA
			0.9	1.10		I _F = 10mA
			1.0	1.20		I _F = 50mA
			1.15	1.35		I _F = 150mA
Leakage Current (Note 5)	I _R	—	—	10.0	nA	V _R = 75V
				100		V _R = 1V, T _J = 150°C
				500		V _R = 75V, T _J = 150°C
Total Capacitance	C _T	—	1.6	3.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	120	3000	ns	I _F = I _R = 10mA, I _{rr} = 0.1 x I _R , R _L = 100Ω

Notes: 4. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
5. Short duration pulse test used to minimize self-heating effect.

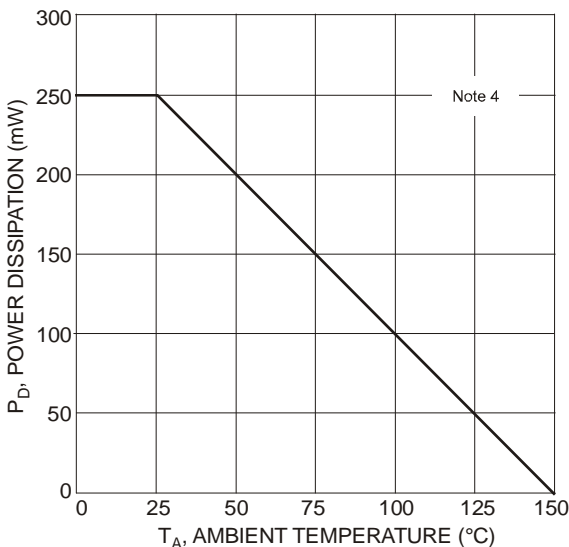


Fig. 1 Power Derating Curve, Total Package

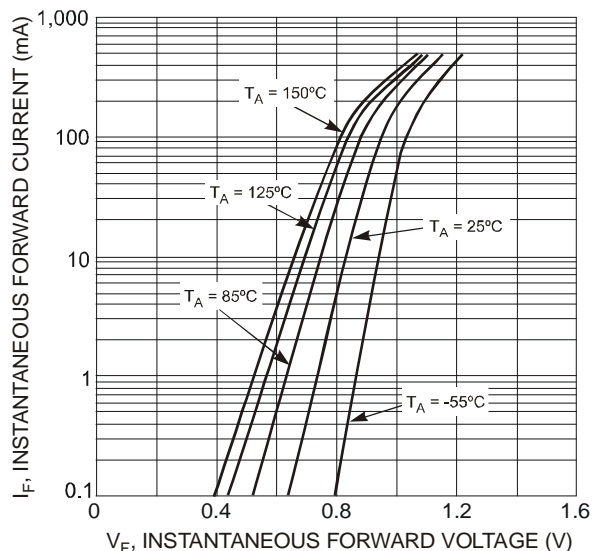


Fig. 2 Typical Forward Characteristics

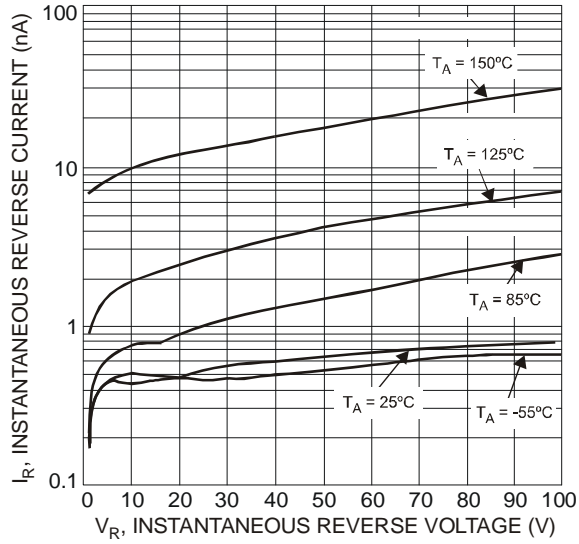


Fig. 3 Typical Reverse Characteristics

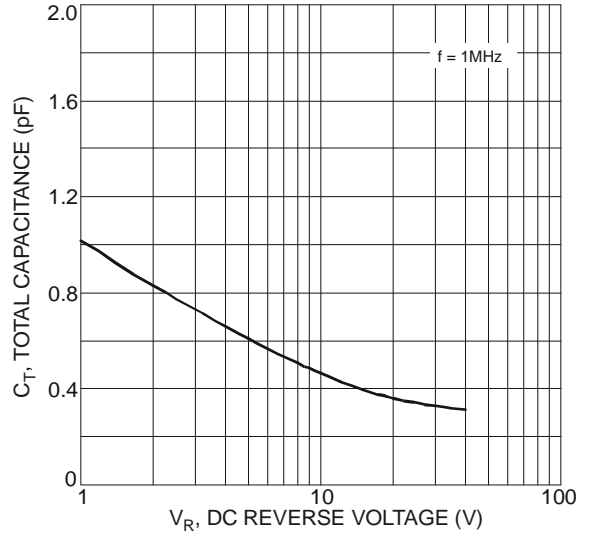
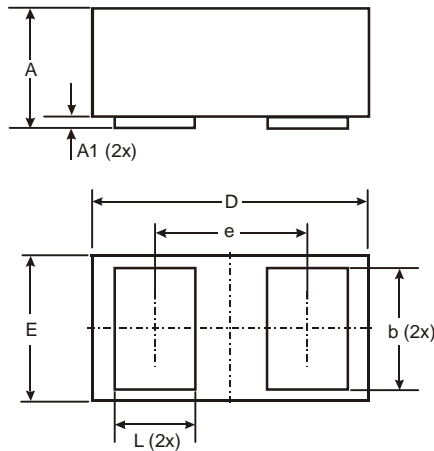


Fig. 4 Typical Total Capacitance vs. Reverse Voltage

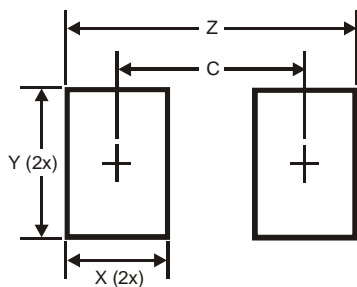
Package Outline Dimensions



Bottom View

X3-DFN0603-2			
Dim	Min	Max	Typ
A	0.27	0.35	0.30
A1	0.00	0.03	0.02
b	0.19	0.29	0.24
D	0.595	0.645	0.62
E	0.295	0.345	0.32
e	-	-	0.355
L	0.14	0.24	0.19
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
C	0.355
X	0.230
Y	0.300
Z	0.610

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